

Features

- Split Gate Trench MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low RDS(ON)

Product Summary



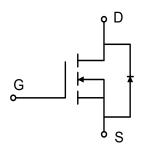
BVDSS	RDSON	ID
100V	3.6mΩ	120A

Applications

- DC-DC Converters
- Power management functions
- Synchronous-rectification applications

PDFN5060-8L Pin Configuration





Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	100	V
V _G s	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ^{1,6}	120	Α
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ^{1,6}	81	Α
I _{DM}	Pulsed Drain Current ²	512	Α
EAS	Single Pulse Avalanche Energy ³	486	mJ
I _{AS}	Avalanche Current	67	Α
P _D @T _C =25°C	Total Power Dissipation ⁴	178	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit	
R _{0JA}	Thermal Resistance Junction-Ambient ¹		56	°C/W	
Rejc	Thermal Resistance Junction-Case ¹		0.8	°C/W	



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	100			V	
$\triangle BV_{DSS}/\triangle T_{J}$	BV _{DSS} Temperature Coefficient	Reference to 25°C , I _D =1mA				V/°C	
В	Static Dunin Course On Besistance?	V _{GS} =10V , I _D =20A		3.6	4.4	mΩ	
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =4.5V , I _D =20A					
V _{GS(th)}	Gate Threshold Voltage	\\ _\\	2.0	3.0	4.0	V	
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$-V_{GS}=V_{DS}$, $I_D=250uA$				mV/°C	
	Proje Course Leakers Current	V _{DS} =80V , V _{GS} =0V , T _J =25°C			1		
I _{DSS}	Drain-Source Leakage Current	V _{DS} =80V, V _{GS} =0V , T _J =100°C			100	· uA	
I _{GSS}	Gate-Source Leakage Current	$V_{GS} = \pm 20V$, $V_{DS} = 0V$			±100	nA	
gfs	Forward Transconductance	V _{DS} =5V , I _D =20A		35		S	
R _g	Gate Resistance	Gate Resistance V _{DS} =0V , V _{GS} =0V , f=1MHz		1.6		Ω	
Q _g	Total Gate Charge			69			
Q _{gs}	Gate-Source Charge	V _{DS} =50V , V _{GS} =10V , I _D =20A		24		nC	
Q _{gd}	Gate-Drain Charge			18.5			
T _{d(on)}	Turn-On Delay Time			18.0			
Tr	Rise Time	VGS=10V, VDD=50V,		23			
T _{d(off)}	Turn-Off Delay Time	RG=3Ω, ID=20A		37		ns	
T _f	Fall Time			15.7			
C _{iss}	Input Capacitance			4102			
Coss	Output Capacitance	V _{DS} =50V , V _{GS} =0V , f=1MHz		592		pF	
C _{rss}	Reverse Transfer Capacitance			19.8			

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I _S	Continuous Source Current ^{1,5}	V _G =V _D =0V , Force Current			120	Α
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1.2	V

 $F\grave{\vdash} he \not A lata \not A ested \not A by \not A surface \not A mounted \not A surface \not A honda \not A factor for the factor fo$

CÈThe Ádata Áested Áby Ápulsed Á ápulse Ávidth Ás 300 us Á áduty Ábycle Ás 2%
HÈThe ÁEAS Ádata Áshows ÁMax. Ádating Á ÁThe Áest Ábondition Ás ÁTJ = 25°C, L = 3.0mH, IAS = 18A, VGS = 10V, VDD = 50V; 100% test at L = 0.1mH, IAS =

I He Apower Adissipation As Aimited Aby A 50°C junction Atemperature

Í 🖹 he Ádata Ás Áheoretically Áhe Ásame Ás Á_{D Á}and Á_{D MÁ} Án Áteal Áspplications Á Áshould Áse Áimited Ásy Átotal Ásower Á dissipation.



Typical Electrical & Thermal Characteristics

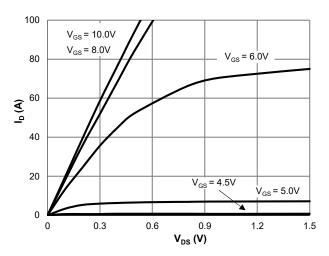


Figure 1: Saturation Characteristics

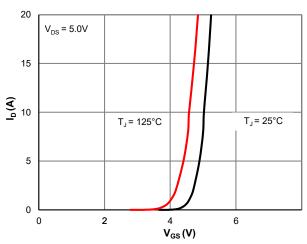


Figure 2: Transfer Characteristics

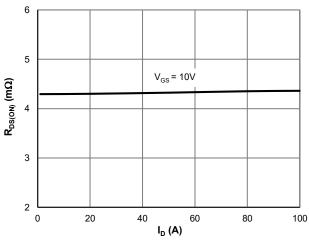


Figure 3: R_{DS(ON)} vs. Drain Current

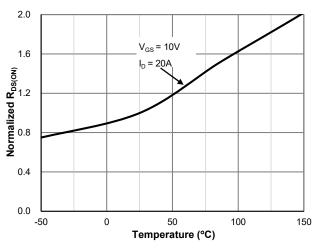


Figure 4: $R_{DS(ON)}$ vs. Junction Temperature

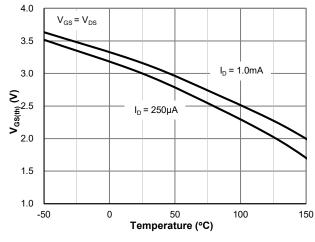


Figure 5: $V_{GS(th)}$ vs. Junction Temperature

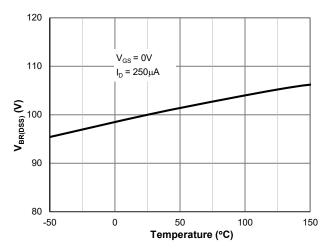


Figure 6: $V_{BR(DSS)}$ vs. Junction Temperature



Typical Electrical & Thermal Characteristics

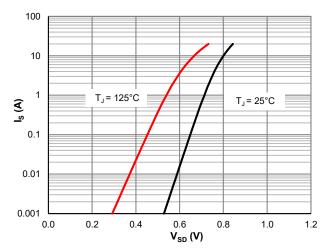


Figure 7: Body-Diode Characteristics

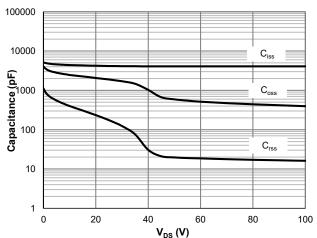


Figure 8: Capacitance Characteristics

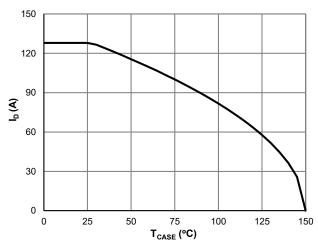


Figure 9: Current De-rating

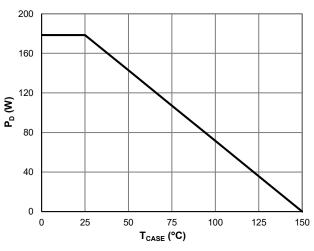


Figure 10: Power De-rating

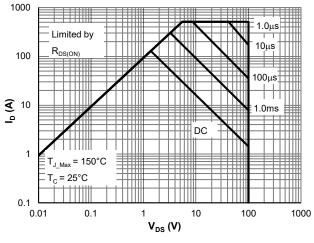


Figure 11: Maximum Safe Operating Area

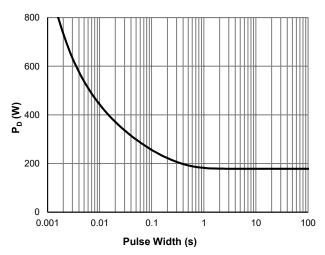


Figure 12: Single Pulse Power Rating, Junction-to-Case



Typical Electrical & Thermal Characteristics

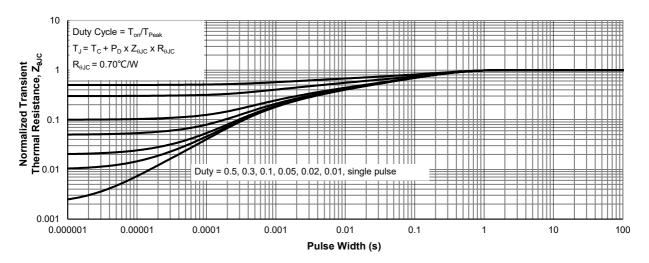
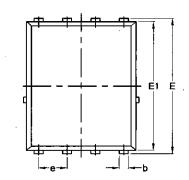
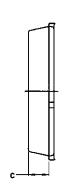


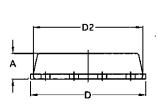
Figure 13: Normalized Maximum Transient Thermal Impedance

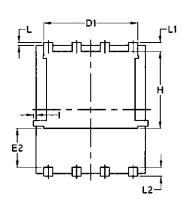


Package Mechanical Data-PDFN5060-8L-JQ Single









Symbol	Common	Common					
	mm	mm					
	Mim	Max	Min	Max			
Α	1.03	1.17	0.0406	0.0461			
b	0.34	0.48	0.0134	0.0189			
С	0.824	0.0970	0.0324	0.082			
D	4.80	5.40	0.1890	0.2126			
D1	4.11	4.31	0.1618	0.1697			
D2	4.80	5.00	0.1890	0.1969			
E	5.95	6.15	0.2343	0.2421			
E1	5.65	5.85	0.2224	0.2303			
E2	1.60	/	0.0630	/			
е	1.27 BSC	1.27 BSC 0.05 BSC					
L	0.05	0.25	0.0020	0.0098			
L1	0.38	0.50	0.0150	0.0197			
L2	0.38	0.50	0.0150	0.0197			
Н	3.30	3.50	0.1299	0.1378			
1	/	0.18	/	0.0070			